RGB LED, 1210

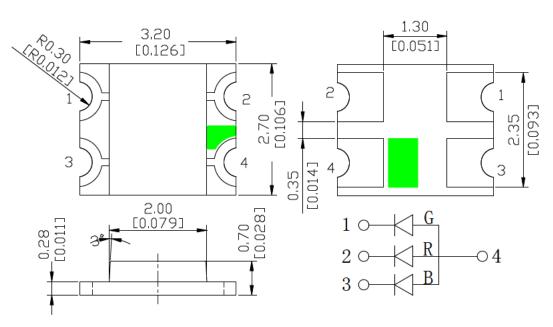


Feature

- Viewing angle:140 deg
- The materials of the LED dice is AlGaInP and InGaN
- 3.20mm×2.70mm×0.70mm
- RoHS compliant lead-free soldering compatible

Package Outline

CC-W2S1210TS-A41





NOTES:

- 1. All dimensions are in millimeters (inches);
- 2. Tolerances are ±0.1mm (0.004inch) unless otherwise noted.



Absolute maximum ratings at Ta=25 $^\circ\!\mathbb{C}$

| Parameter | Symbol | Value | | | Unit |
|-----------------------------|--------|-------|-----------|----|------|
| raiallietei | Symbol | R | G | В | Unit |
| Power dissipation | Pd | 48 | 68 | 68 | mW |
| Forward current | lf | | 20 | | mA |
| Reverse voltage | Vr | | 5 | | V |
| Operating temperature range | Тор | | -40~+100 | | °C |
| Storage temperature range | Tstg | | -40~+100 | | °C |
| Pulse Forward Current | lfp | | 100 | | mA |
| Electrostatic Discharge | ESD | | 1000(HBM) | | V |

Electro-optical characteristics at Ta=25 $^{\circ}\mathbb{C}$

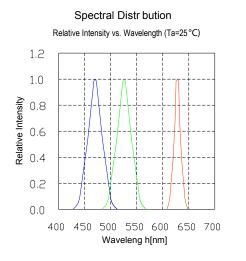
| Doromotor | Test Condition Symbol | | Test Condition | | | | Value | | Unit |
|-------------------------|---------------------------|--------------------|------------------|------|------|------|-------|--|------|
| Parameter | lest Condition | lest Condition Syr | | Min. | Тур. | Max. | omit | | |
| | | | R | | 15 | | | | |
| Spectral Half bandwidth | lf=20mA | Δλ | G | | 30 | | nm | | |
| | | | В | | 30 | | | | |
| | | | R | 1.8 | | 2.4 | V | | |
| Forward voltage | lf=20mA | lf=20mA Vf | age If=20mA Vf G | 2.7 | | 3.5 | | | |
| | | | В | 2.7 | | 3.5 | | | |
| | | R 630 640 | 640 | | | | | | |
| Dominant wavelength | ength If=20mA λd | G | 515 | | 530 | nm | | | |
| | | | В | 465 | | 475 | | | |
| | nsity If=20mA Iv G 200 56 | | R | 35 | | 100 | | | |
| Luminous intensity | | 560 | mcd | | | | | | |
| | | | 200 | | | | | | |
| Viewing angle at 50% lv | lf=20mA | 2 0 | 1/2 | | 140 | | Deg | | |
| Reverse current | Vr=5V | I | r | | | 10 | μA | | |

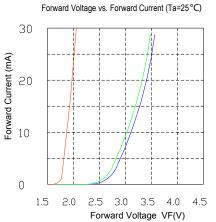
NOTE: (Tolerance: lv ±10%, λ_d ±2nm, Vf ±0.05V)

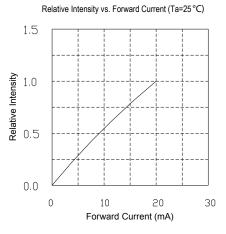
IFP Conditions: Pulse Width \leq 10msec. and Duty \leq 1/10.



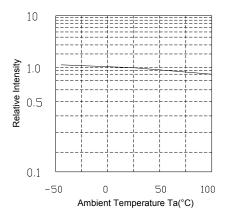
Typical optical characteristics curves

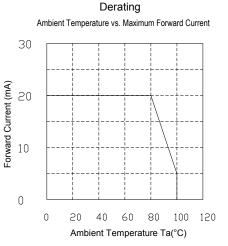


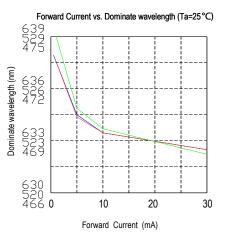


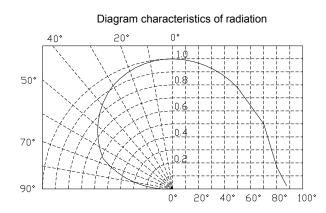


Relative Intensity vs. Ambient Temperature









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Reflow profile

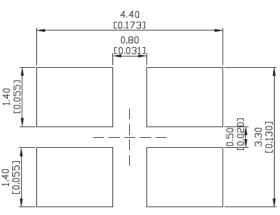
- Soldering condition
 - · Recommended soldering conditions

| Reflow Soldering | | Hand Soldering | | |
|------------------|------------------------------|----------------|-----------------|--|
| Pre-heat | 160∼180°C | Temperature | 300°С Мах. | |
| Pre-heat time | 120 seconds Max. | | | |
| Peak temperature | 260 ℃ Max. | Soldering time | 3 second Max. | |
| Soldering time | 10 seconds Max. | | (one time only) | |
| Condition | Refer to Temperature-profile | | | |

- After reflow soldering rapid cooling should be avoided
- Temperature-profile (Surface of circuit board) Use the following conditions shown in the figure. IR-Reflow Soldering Profile for lead Soldering

300 10 sec Max °C Above 255°C 260% 250 30sec Max 5°C /sec Max Above 220°C 120 sec. Max. 150sec Max 200 150 100 50 25°C 0 90 180 240 s 300

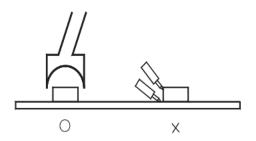
RECOMMEND PAD DESIGN (Units: mm)



- 1. Reflow soldering should not be done more than two times
- 2. When soldering ,do not put stress on the LEDs during heating
- Soldering iron
 - 1. When hand soldering, keep the temperature of the iron under 300 °C, and at that temperature keep the time under 3 sec.
 - 2. The hand soldering should be done only a time
 - 3. The basic spec is ≤5 sec. when the temperature of 260 °C, do not contact the resin when hand soldering

Rework

- 1. Customer must finish rework within 5 sec under 260 $^\circ\!\mathrm{C}$
- 2. The head of iron can not touch the resin
- 3. Twin-head type is preferred.





Reliability (1)TEST ITEMS AND RESULTS

| Туре | Test Item | Ref. Standard | Test Conditions | Note | Number of Damaged |
|---------------------------|--|---------------|---|-----------|-------------------|
| | Resistance to Soldering Heat(Reflow Soldering) | JESD22-B106 | Tsld=260℃,10sec | 2 times | 0/22 |
| iental ice | Temperature Cycle | JESD22-A104 | -40°C 30min ↑↓5min 100°C 30min | 300 cycle | 0/22 |
| Environmental Sequence | Thermal Shock | JESD22-A106 | -40℃ 15min ↑↓ 100℃ 15min | 300 cycle | 0/22 |
| | High Temperature Storage | JESD22-A103 | T _a =100℃ | 1000 hrs | 0/22 |
| | Low Temperature Storage | JESD22-A119 | T _a =-40°C | 1000 hrs | 0/22 |
| ation ence | Life Test | JESD22-A108 | T _a =25℃ I _F =20mA | 1000 hrs | 0/22 |
| Operation Sequence | High Humidity Heat Life Test | JESD22-A101 | 60℃ RH=90% I _F =20mA | 1000 hrs | 0/22 |

(2) CRITERIA FOR JUDGING THE DAMAGE

| ltere | theme Owned Test Owned the | Criteria for Judgement | | |
|--------------------|----------------------------|------------------------|--------------|-------------|
| Item | Symbol | Test Conditions | Min. | Max. |
| Forward Voltage | VF | IF=20mA | _ | U.S.L*)×1.1 |
| Reverse Current | IR | VR=5V | _ | U.S.L*)×2.0 |
| Luminous Intensity | IV | IF=20mA | L.S.L**)×0.7 | _ |

U.S.L.: Upper Standard Level

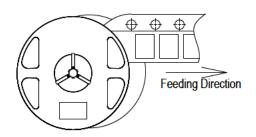
L.S.L.: Lower Standard Level

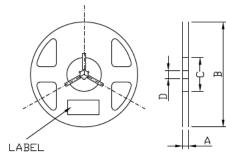


Packaging Specifications

• Feeding Direction

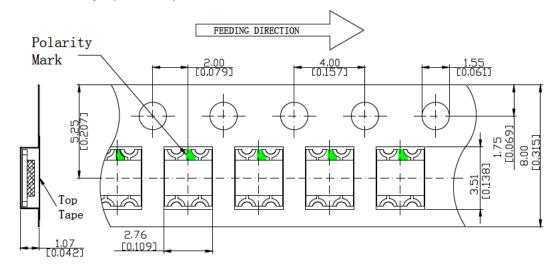
• Dimensions of Reel (Unit: mm)



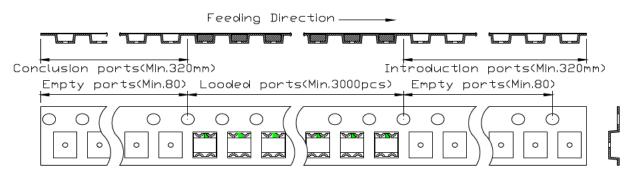


| Α | 8.0±0.1mm |
|---|-----------------------|
| В | $178 \pm 1 \text{mm}$ |
| С | 60 ± 1 mm |
| D | 13.0±0.5mm |

• Dimensions of Tape (Unit: mm)



• Arrangement of Tape



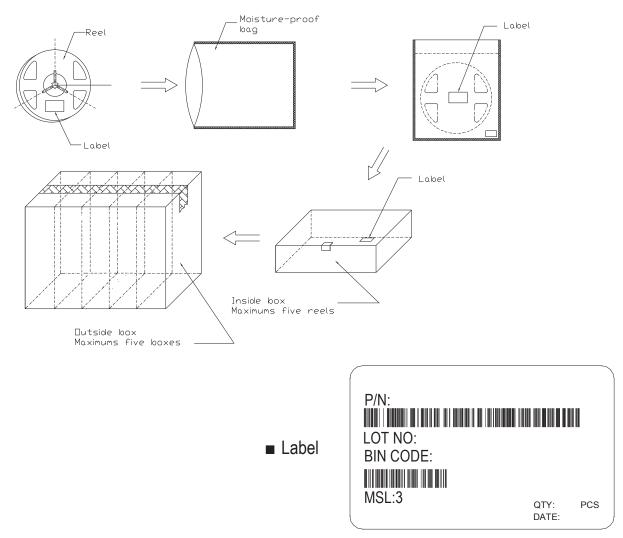
NOTES

- 1. Empty component pockets are sealed with top cover tape;
- 2. The maximum number of missing lamps is two;
- 3. 3,000 pcs/ Reel.

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Packaging specifications



CAUTIONS

Package specifications

Reeled products (numbers of products are 3,000pcs) packed in a seal off moisture-proof bag along with a desiccant one by one, Five moisture-proof bag of maximums (total maximum number of products are 15,000pcs) packed in an inside box (size: about 250mm x about 250 x about 68mm) and Five inside boxes of maximums are put the outside box (size: about 360mm x about 265mm x about 255mm) Together with buffer material, and it is packed. (Pare No., Lot No., quantity should appear on the label on the moisture-proof bag, part No. And quantity should appear on the label on the cardboard box.) The number of the loading steps of outside box (cardboard box) has three steps.

Storage conditions

Before opening the package:

The LEDs should be kept at 30° C or less and 70%RH or less. The LEDs should be used within a year. When storing the LEDs, moisture proof packaging with absorbent material is recommended.

After opening the package:

The LEDs should be kept at 30 °C or less and 60%RH or less. The LEDs should be soldered within 168 hours (7days) after opening the package. If unused LEDs remain, they should be stored in moisture proof packages, such as sealed containers with packages of moisture absorbent material. It is also recommended to return the LEDs to the original moisture proof bag and to reseal the moisture proof bag again.